

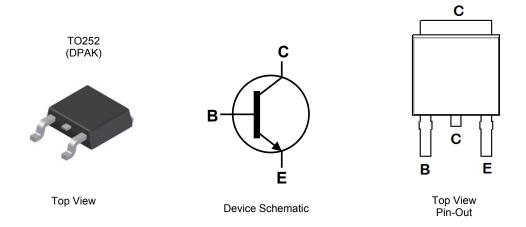
460V NPN HIGH VOLTAGE POWER TRANSISTOR IN TO252

Features

- BV_{CEO} > 460V
- BV_{CES} > 700V
- BV_{EBO} > 9V
- I_C = 1.5A high Continuous Collector Current
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.34 grams (approximate)



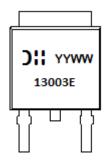
Ordering Information (Note 4)

| ſ | Product | Compliance | Marking | Reel Size (inches) | Tape Width (mm) | Quantity per Reel |
|---|---------------|------------|---------|--------------------|-----------------|-------------------|
| | DXT13003EK-13 | Standard | 13003E | 13 | 16 | 2,500 |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



13003E = Product Type Marking Code

Jii = Manufacturer's Code Marking

YYWW = Date Code Marking

YY = Last Digit of Year (ex: 14 = 2014)

WW = Week Code (01-53)



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|------------------|-------|------|
| Collector-Emitter Voltage (V _{BE} = 0V) | V _{CES} | 700 | V |
| Collector-Emitter Voltage | V _{CEO} | 460 | V |
| Emitter-Base Voltage | V _{EBO} | 9 | V |
| Continuous Collector Current | Ic | 1.5 | A |
| Peak Pulse Collector Current (Note 5) | Ісм | 3 | Α |
| Continuous Base Current | I _B | 0.75 | A |
| Peak Pulse Base Current (Note 5) | I _{BM} | 1.5 | A |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Value | Unit | |
|--|-----------------------------------|------------------|-------|------|--|
| | (Note 6) | | 3.9 | | |
| Power Dissipation | (Note 7) | P _D | 2.5 | W | |
| Power Dissipation | (Note 8) | | 2.1 | | |
| | (Note 9) | | 1.6 | | |
| | (Note 6) | R _{eJA} | 32 | | |
| Thermal Resistance, Junction to Ambient Air | (Note 7) | | 51 | | |
| Thermal Resistance, Junction to Ambient All | (Note 8) | | 59 | °C/W | |
| | (Note 9) | | 80 | | |
| Thermal Resistance, Junction to Leads (Note 10 | | $R_{	heta JL}$ | 3 | | |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C | | |

ESD Ratings (Note 11)

| Characteristic | Symbol | Value | Unit | JEDEC Class |
|--|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 8,000 | V | 3B |
| Electrostatic Discharge - Machine Model | ESD MM | 400 | V | С |

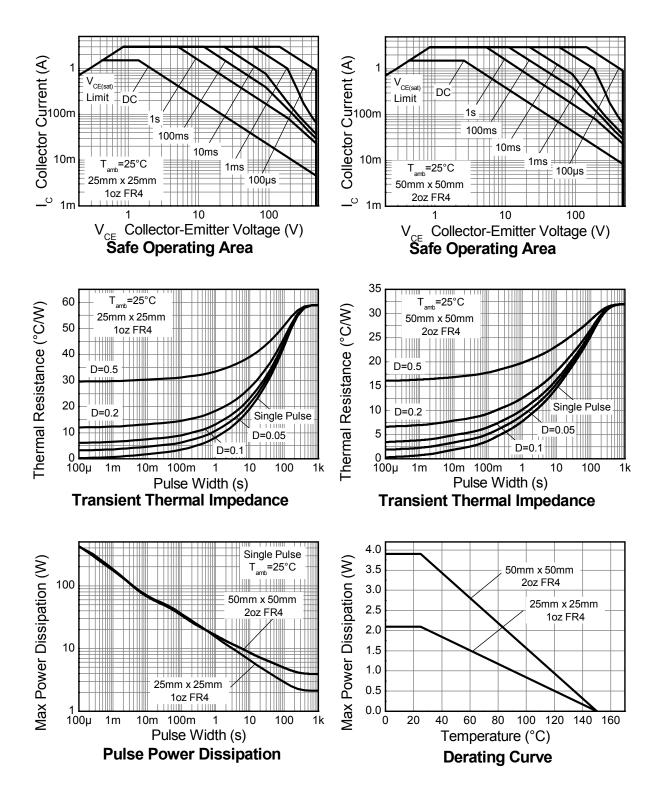
Notes:

- Pulse test for pulse width < 5ms, duty cycle ≤ 10%.
 For a device mounted with the exposed collector pad on 50mm x 50mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
 Same as note (6), except the device is surface mounted on 25mm x 25mm 2oz copper.
 Same as note (6), except the device is surface mounted on 25mm x 25mm 1oz copper.
 Same as note (6), except mounted on minimum recommended pad (MRP) layout.
 Therest resistance from instance and a resist (on the exposed collector and).

- Thermal resistance from junction to solder-point (on the exposed collector pad).
 Refer to JEDEC specification JESD22-A114 and JESD22-A115.



Thermal Characteristics and Derating Information





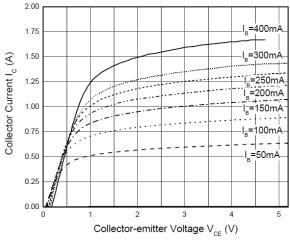
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|----------------------|---------------|--------------|---------------|------|--|
| Collector-Emitter Breakdown Voltage | BV _{CES} | 700 | _ | _ | V | $I_C = 100 \mu A, V_{BE} = 0 V$ |
| Collector-Emitter Breakdown Voltage | BV _{CEO} | 460 | _ | _ | V | I _C = 100μA |
| Emitter-Base Breakdown Voltage | BV _{EBO} | 9 | _ | _ | V | I _E = 100μA |
| Collector Cutoff Current | I _{CEV} | 1 | _ | 10 | μΑ | V _{CE} = 700V, V _{BE} = -1.5V |
| DC current transfer Static ratio (Note 12) | h _{FE} | 15 14 5 | _ 17 _ | — 30 25 | | $I_C = 0.3A$, $V_{CE} = 2V$ $I_C = 0.5A$, $V_{CE} = 2V$ $I_C = 1.0A$, $V_{CE} = 2V$ |
| Collector-Emitter Saturation Voltage (Note 12) | V _{CE(sat)} | _ | 0.17 0.29 | 0.3 0.4 | V | $I_C = 0.5A, I_B = 0.1A$ $I_C = 1A, I_B = 0.25A$ |
| Base-Emitter Saturation Voltage (Note 12) | V _{BE(sat)} | | | 1.0 1.2 | V | $I_C = 0.5A$, $I_B = 0.1A$ $I_C = 1A$, $I_B = 0.25A$ |
| Output Capacitance | C_{ob} | - | 16 | - | pF | V _{CB} = 10V, f = 0.1MHz |
| Transition Frequency | f _T | 4 | _ | _ | MHz | I _C = 0.1A, V _{CE} = 10V |
| Turn-on Time with Resistive Load | ton | _ | 0.43 | _ | | |
| Storage Time with Resistive Load | ts | _ | 1.64 | _ | μs | $I_C = 1A, V_{CC} = 125V, I_{B1} = 0.2A,$ $I_{B2} = -0.2A$ |
| Fall Time with Resistive Load | t _f | 1 | 0.28 | | | IBZ V.Z.A |

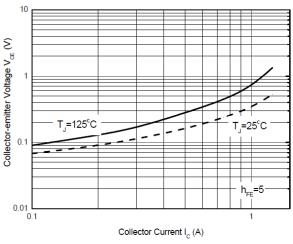
Note: 12. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.



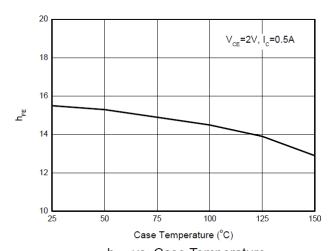
Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)



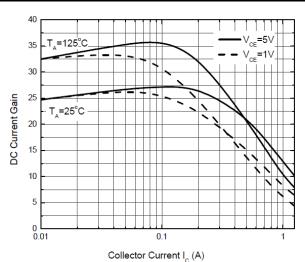
Static Characteristics



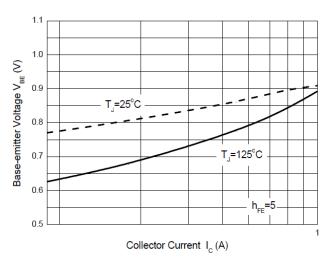
Collector-emitter Saturation Voltage



 $h_{\mbox{\scriptsize FE}}$ vs. Case Temperature



DC Current Gain vs. Collector Current

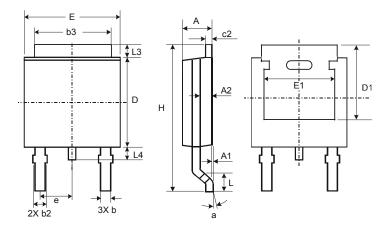


Base-emitter Saturation Voltage



Package Outline Dimensions

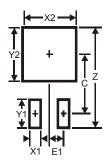
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| TO252 | | | | | | |
|-----------|----------------------|-------|-------|--|--|--|
| Dim | Min | Max | Тур | | | |
| Α | 2.19 | 2.39 | 2.29 | | | |
| A1 | 0.00 | 0.13 | 0.08 | | | |
| A2 | 0.97 | 1.17 | 1.07 | | | |
| b | 0.64 | 0.88 | 0.783 | | | |
| b2 | 0.76 | 1.14 | 0.95 | | | |
| b3 | 5.21 | 5.46 | 5.33 | | | |
| c2 | 0.45 | 0.58 | 0.531 | | | |
| D | 6.00 | 6.20 | 6.10 | | | |
| D1 | 5.21 | _ | _ | | | |
| е | _ | _ | 2.286 | | | |
| Е | 6.45 | 6.70 | 6.58 | | | |
| E1 | 4.32 | _ | - | | | |
| Н | 9.40 | 10.41 | 9.91 | | | |
| L | 1.40 | 1.78 | 1.59 | | | |
| L3 | 0.88 | 1.27 | 1.08 | | | |
| L4 | 0.64 | 1.02 | 0.83 | | | |
| а | 0° | 10° | _ | | | |
| All | All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) | | |
|------------|---------------|--|--|
| Z | 11.6 | | |
| X1 | 1.5 | | |
| X2 | 7.0 | | |
| Y1 | 2.5 | | |
| Y2 | 7.0 | | |
| С | 6.9 | | |
| F1 | 2.3 | | |

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



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